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Name of Person Mailing Paper. Aimee Harrison

PATENT

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Serial No:

10/699,627

Filing Date:

October 31, 2003

Art Unit:

3754

Applicant:

Babiarz et al.

Title:

METHOD OF NONCONTACT DISPENSING OF VISCOUS

**MATERIAL** 

Atty Docket:

NOR-1147

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

## INFORMATION DISCLOSURE STATEMENT

In accordance with the duty of candor and good faith imposed by 37 CFR §1.56 and means of complying therewith according to 37 CFR §§1.97 and 1.98, the references listed on the attached PTO-1449 are called to the attention of the United States Patent and Trademark Office in connection with the above-identified patent application.

This application was filed after June 30, 2003, and therefore, no copies are enclosed of the U.S. Patents or Published applications cited as references herein.

No admission is made that the cited art represents the prior art or that the cited art is the most material art. Applicant submits that none of the cited references alone or in combination disclose or render obvious the subject matter in the present invention. The Examiner is urged to consider the cited references and to make an independent decision with respect to their materiality.

Respectfully submitted,

WOOD, HERRON & EVANS, L

C. Richard Eby, Reg. No. 25,854

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EXAMINER: Initial if citation considered, whether or not in conformance. Draw line through citation only if not in conformance <u>and</u> not considered. Include a copy of this form with next communication to applicant.

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